ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES international and Pan-American co	ourn. Illinois. All rights reserved u	under both This doc level par	ument is a declarat ts, the declaration of	ion of the substance encompasses all low	es within the manufactur wer level materials for wl	er listed item. Note hich the manufactu	e: if the item is an as arer has engineering	ssembly with lower responsibility.	
IPC Web Site for Information on I   http://www.ipc.org/IPC-175x	beb Site for Information on IPC-1752 Standard Form Type www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					
Supplier Information									
Company name*	y name* Company unique ID		Unique ID Authority			Response Date*			
onsemi						2023-06-08			
Contact Name	Title - Contact		Phone - Contact*			Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com			
Authorized Representative*	ized Representative* Title - Representative		Phone - Representative*			Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item	Number Mfr Item Name	Mfr Item Name		e Version	Manufacturing Site	Weight*	UOM	Unit Type	
NCP316	3PWR2G ANA 2.5 A STE	P UP/DWN/INV	2023-06-08 PH1		422.02	mg	Each		
Manufacturing Proccess Information									
Terminal Plating / Grid Array Material	erminal Base Alloy	J-STD-020 MSL Rating	Peak Proc	Peak Process Body Temperatur		Temperature Nu	mber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy 1		1	260	С	30	seconds 3			
Comments									
evel 1 - maximum time at peak temperature during so	dering is 10-30 seconds								
For more information regarding material composition	0								

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.84	mg	Supplier	Silicon (Si)	7440-21-3		5.84	mg
Die Attach	16.72	mg		Epoxy resin	proprietary data		0.418	mg
			Supplier	Silver (Ag)	7440-22-4		14.1284	mg
			Supplier	Phenolic Resin	Proprietary Data		0.418	mg
			Supplier	Inorganic filler	Proprietary Data		0.418	mg
			Supplier	Dicyandiamine	461-58-5		0.0836	mg
			Supplier	Formaldehyde Polymer	9003-36-5		1.254	mg
Lead Frame	261.87	mg	Supplier	Silver (Ag)	7440-22-4		2.8806	mg
			Supplier	Zinc (Zn)	7440-66-6		0.5237	mg
			Supplier	Iron (Fe)	7439-89-6		6.8086	mg
			Supplier	Copper (Cu)	7440-50-8		251.6571	mg
Mold Compound-Black	133.38	133.38 mg		Epoxy resin	proprietary data		6.669	mg
			Supplier	Phenolic Resin	Proprietary Data		2.6676	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.3345	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6669	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		120.042	mg
Plating	3.83	mg	Supplier	Tin (Sn)	7440-31-5		3.83	mg
Wire Bond - Au	0.38	mg	Supplier	Gold (Au)	7440-57-5		0.38	mg